



Product data sheet

Product profile 1.

1.1 General description

PNP transistor in a SOT323 (SC-70) plastic package. The NPN complement is 2PC4081.

1.2 Features

- Low current (max. 150 mA)
- Low voltage (max. 50 V)
- Low collector capacitance (typ. 2.5 pF)

1.3 Applications

■ General-purpose switching and amplification

2. **Pinning information**

Table 1. **Pinning**

Pin	Description	Simplified outline	Symbol
1	base		_
2	emitter	<u> </u>	3
3	collector	1 2	1 —
			sym013

Ordering information 3.

Ordering information Table 2.

Type number	Package	Package					
	Name	Description	Version				
2PA1576Q	SC-70	plastic surface mounted package; 3 leads	SOT323				
2PA1576R							
2PA1576S							



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4. Marking

Table 3. Marking codes

Type number	Marking code ^[1]
2PA1576Q	F*Q
2PA1576R	F*R
2PA1576S	F*S

^{[1] * = -:} made in Hong Kong

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	-60	V
V_{CEO}	collector-emitter voltage	open base	-	-50	V
V_{EBO}	emitter-base voltage	open collector	-	-6	V
I _C	collector current (DC)		-	-150	mA
I _{CM}	peak collector current		-	-200	mA
I _{BM}	peak base current		-	-200	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	<u>[1]</u> _	200	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

^[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient		<u>[1]</u> -	-	625	K/W

^[1] Transistor mounted on an FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

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^{* =} t: made in Malaysia

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Characteristics

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Table 6. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CBO}	collector-base cut-off current	$I_E = 0 A; V_{CB} = -30 V$	-	-	-100	nA
		$I_E = 0 \text{ A}; V_{CB} = -30 \text{ V};$ $T_j = 150 \text{ °C}$	-	-	-5	μΑ
I _{EBO}	emitter-base cut-off current	$I_C = 0 A; V_{EB} = -4 V$	-	-	-100	nA
h _{FE}	DC current gain	$I_C = -1 \text{ mA}; V_{CE} = -6 \text{ V}$				
	2PA1576Q		120	-	270	
	2PA1576R		180	-	390	
	2PA1576S		270	-	560	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -50 \text{ mA};$ $I_B = -5 \text{ mA}$	[1] -	-	-500	mV
C _c	collector capacitance	$I_E = i_e = 0 \text{ A};$ $V_{CB} = -12 \text{ V}; f = 1 \text{ MHz}$	-	2.5	3.5	pF
f _T	transition frequency	$I_C = -2 \text{ mA};$ $V_{CE} = -12 \text{ V};$ f = 100 MHz	100	-	-	MHz

^[1] Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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Package outline 8.

Plastic surface-mounted package; 3 leads **SOT323** В Α X H_{E} = v (M) A Q **→** | w (M) B е detail X 2 mm scale **DIMENSIONS** (mm are the original dimensions) UNIT D С Ε Q bp e₁ ΗE $L_{\mathbf{p}}$ w max 0.25 2.2 1.35 0.23 0.1 1.3 0.65 0.2 0.2 mm 0.8 0.10 1.15 REFERENCES **EUROPEAN** OUTLINE **ISSUE DATE** PROJECTION VERSION IEC **JEDEC JEITA** 04-11-04 SOT323 SC-70

Package outline SOT323 (SC-70) Fig 1.

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9. Revision history

Table 7. Revision history

Release date	Data sheet status	Change notice	Supersedes
20091117	Product data sheet	-	2PA1576_5
including new le content.	egal definitions and disclair	mers. No changes we	
 Figure 1 "Packa" 	age outline SOT323 (SC-70	<u>))"</u> : updated	
20041124	Product data sheet	-	2PA1576_4
19990531	Product specification	-	2PA1576_3
19970328	Objective specification	-	2PA1576_2
19931213	n.a.	-	n.a.
	20091117 • This data sheer including new location. • Figure 1 "Packate 20041124 19990531 19970328	 Product data sheet This data sheet was changed to reflect the including new legal definitions and disclair content. Figure 1 "Package outline SOT323 (SC-7020041124 Product data sheet 19990531 Product specification 19970328 Objective specification 	Product data sheet - This data sheet was changed to reflect the new company name including new legal definitions and disclaimers. No changes we content. Figure 1 "Package outline SOT323 (SC-70)": updated 20041124 Product data sheet - 19990531 Product specification - 19970328 Objective specification -

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10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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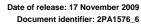
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